

Title (en)
SUBSTRATE CARRIER

Title (de)
SUBSTRATHALTER

Title (fr)
SUPPORT DE SUBSTRAT

Publication
EP 1145292 A1 20011017 (DE)

Application
EP 99963537 A 19991215

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Abstract (en)
[origin: DE19859467A1] The invention relates to a substrate carrier for holding substrates, especially semiconductor wafers. Good sealing of the wafer surface and electrical contact are made possible in that the substrate carrier has a first and a second part having a central opening matching the form of the substrate, wherein the substrate is received between the first and the second part and a peripheral seal having at least one undercut is provided in the inner periphery of the second part.

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IPC 8 full level
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